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## PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan     | Lead finish/<br>Ball material | MSL Peak Temp      | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|--------------|-------------------------------|--------------------|--------------|----------------------|---------|
| CD74HC4067M96    | ACTIVE | SOIC         | DW                 | 24   | 2000           | RoHS & Green | (6)<br>NIPDAU   SN            | Level-1-260C-UNLIM | -55 to 125   | HC4067M              | Samples |
| CD74HC4067SM96   | ACTIVE | SSOP         | DB                 | 24   | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -55 to 125   | HP4067               | Samples |
| CD74HC4067SM96E4 | ACTIVE | SSOP         | DB                 | 24   | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -55 to 125   | HP4067               | Samples |
| CD74HC4067SM96G4 | ACTIVE | SSOP         | DB                 | 24   | 2000           | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -55 to 125   | HP4067               | Samples |
| CD74HCT4067M     | ACTIVE | SOIC         | DW                 | 24   | 25             | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -55 to 125   | HCT4067M             | Samples |
| CD74HCT4067ME4   | ACTIVE | SOIC         | DW                 | 24   | 25             | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -55 to 125   | HCT4067M             | Samples |
| CD74HCT4067MG4   | ACTIVE | SOIC         | DW                 | 24   | 25             | RoHS & Green | NIPDAU                        | Level-1-260C-UNLIM | -55 to 125   | HCT4067M             | Samples |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

## **PACKAGE OPTION ADDENDUM**

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(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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## OTHER QUALIFIED VERSIONS OF CD74HCT4067:

Automotive: CD74HCT4067-Q1

NOTE: Qualified Version Definitions:

• Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects